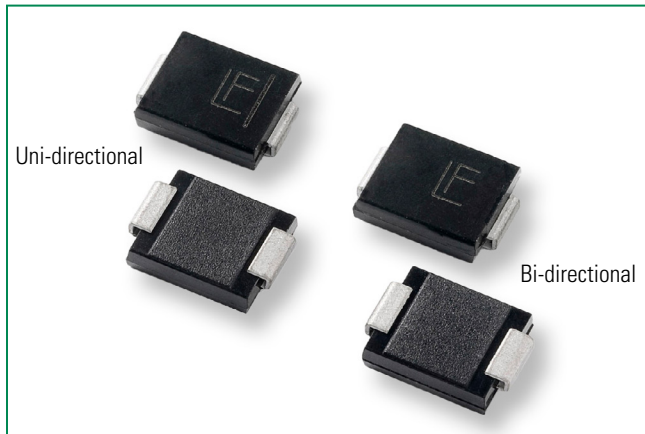


# TP5.0SMDJ Series

## Surface Mount - 5000W



### Maximum Ratings & Thermal Characteristics


( $T_A=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at $T_L=25^\circ\text{C}$ by 10/1000 $\mu\text{s}$ Waveform (Fig.2)(Note 1), (Note 2)	$P_{PPM}$	5000	W
Power Dissipation on Infinite Heat Sink at $T_L=50^\circ\text{C}$	$P_{M(AV)}$	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	$I_{FSM}$	300	A
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	$V_F$	5.0	V
Operating Temperature Range	$T_J$	-65 to 150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-65 to 175	$^\circ\text{C}$
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	15	$^\circ\text{C/W}$
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	75	$^\circ\text{C/W}$

#### Notes:

1. Non-repetitive current pulse per Fig. 4 and derated above  $T_A=25^\circ\text{C}$  per Fig. 3.
2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum.

### Agency Approvals

Agency	Agency File Number
	E230531



### Description

The TP5.0SMDJ series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

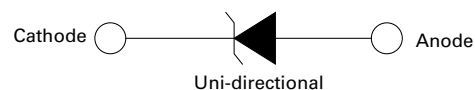
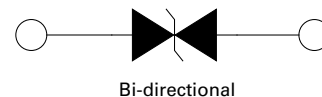
### Features & Benefits

- High reliability application and automotive grade AEC-Q101 qualified
- 5000W peak pulse power capability at 10/1000 $\mu\text{s}$  waveform, repetition rate (duty cycles):0.01%
- SMD low profile surface mount package minimizing PCB footprint
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2, 30kV(Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- Glass passivated chip junction
- Fast response time: typically less than 1.0ps from 0V to  $V_{BR}$  min
- Excellent clamping capability
- Low incremental surge resistance
- Typical  $I_R$  less than 5 $\mu\text{A}$  when  $V_{BR\ min}>22\text{V}$
- High temperature reflow soldering guaranteed: 260 $^\circ\text{C}$ /40sec
- $V_{BR} @ T_J = V_{BR} @ 25^\circ\text{C} \times (1 + \alpha T \times (T_J - 25))$  ( $\alpha T$ : Temperature Coefficient)
- UL Recognized compound meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, LF maximum peak of 260 $^\circ\text{C}$
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)
- Recognized to UL 497B as an Isolated Loop Circuit Protector

### Applications

TVS Components are ideal for the protection of I/O Interfaces,  $V_{CC}$  bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

#### Functional Diagram



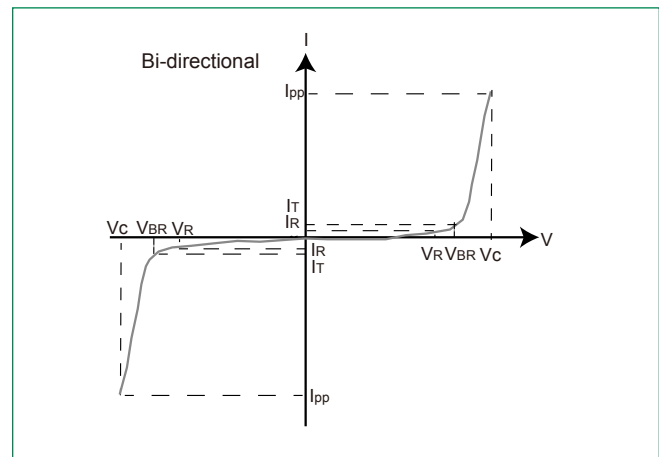
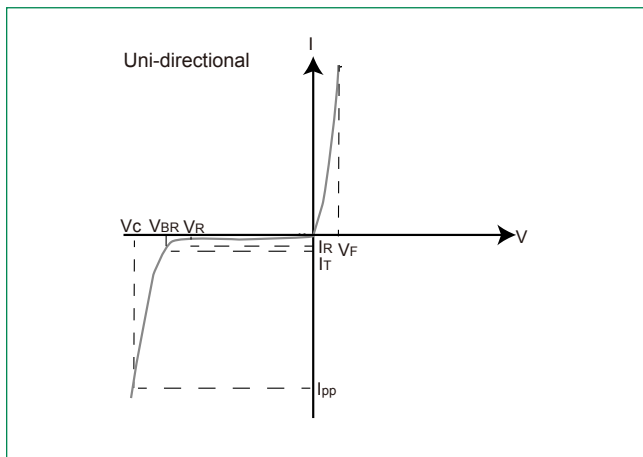
# TP5.0SMDJ Series

## Surface Mount - 5000W

### Electrical Characteristics

Part Number (Uni)	Part Number (Bi)	Marking		Reverse Stand off Voltage $V_R$ (Volts)	Breakdown Voltage $V_{BR}$ (Volts) @ $I_T$		Test Current $I_T$ (mA)	Maximum Clamping Voltage $V_C$ @ $I_{PP}$ (10/1000 $\mu$ s) (V)	Maximum Peak Pulse Current $I_{PP}$ (10/1000 $\mu$ s) (A)	Maximum Clamping Voltage $V_C$ @ $I_{PP}$ (8/20 $\mu$ s) (V)	Maximum Peak Pulse Current $I_{PP}$ (8/20 $\mu$ s) (A)	Maximum Reverse Leakage $I_R$ @ $V_R$ ( $\mu$ A)	Maximum Temperature coefficient of $V_{BR}$ (%/C)	®
		UNI	BI		MIN	MAX								
TP5.0SMDJ100A	TP5.0SMDJ100CA	T5PGZ	T5BGZ	100	111	123	1	162	30.9	209.3	231.8	5	0.107	X
TP5.0SMDJ110A	TP5.0SMDJ110CA	T5PHE	T5BHE	110	122	135	1	177	28.3	228.7	212.3	5	0.107	X
TP5.0SMDJ120A	TP5.0SMDJ120CA	T5PHG	T5BHG	120	133	147	1	193	26	249.4	195	5	0.108	X
TP5.0SMDJ130A	TP5.0SMDJ130CA	T5PHK	T5BHK	130	144	159	1	209	24	270	180	5	0.108	X
TP5.0SMDJ140A	TP5.0SMDJ140CA	T5PHL	T5BHL	140	156	172	1	226.1	22.2	292.1	166.5	5	0.108	X
TP5.0SMDJ150A	TP5.0SMDJ150CA	T5PHM	T5BHM	150	167	185	1	243	20.6	314	154.5	5	0.108	X
TP5.0SMDJ160A	TP5.0SMDJ160CA	T5PHP	T5BHB	160	178	197	1	259	19.3	334.6	144.8	5	0.108	X
TP5.0SMDJ170A	TP5.0SMDJ170CA	T5PHR	T5BHR	170	189	209	1	275	18.2	355.3	136.5	5	0.108	X

### I-V Curve Characteristics



- $P_{PPM}$  Peak Pulse Power Dissipation** -- Max power dissipation
- $V_R$  Stand-off Voltage** -- Maximum voltage that can be applied to the TVS without operation
- $V_{BR}$  Breakdown Voltage** -- Maximum voltage that flows though the TVS at a specified test current ( $I_T$ )
- $V_C$  Clamping Voltage** -- Peak voltage measured across the TVS at a specified  $I_{ppm}$  (peak impulse current)
- $I_R$  Reverse Leakage Current** -- Current measured at  $V_R$
- $V_F$  Forward Voltage Drop for Uni-directional**

# TP5.0SMDJ Series

Surface Mount - 5000W

## Ratings and Characteristic Curves ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

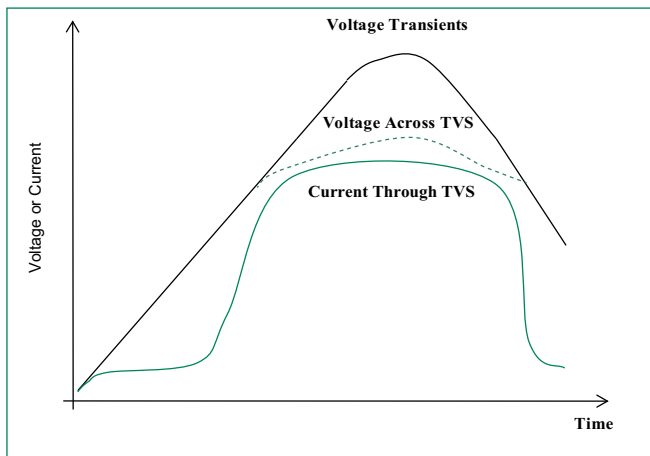


Figure 2 - Peak Pulse Power Rating

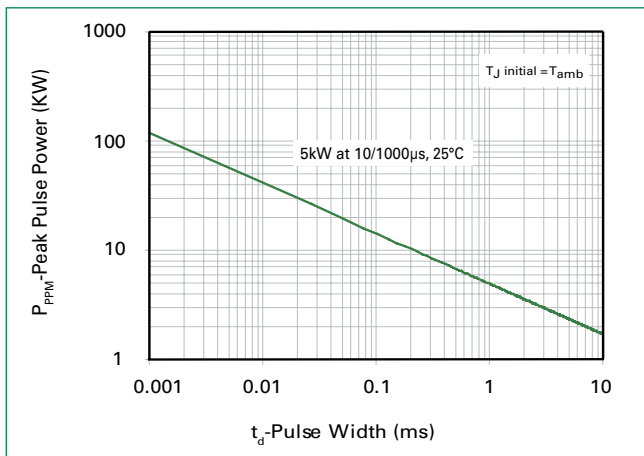


Figure 3 - Peak Pulse Power Derating Curve

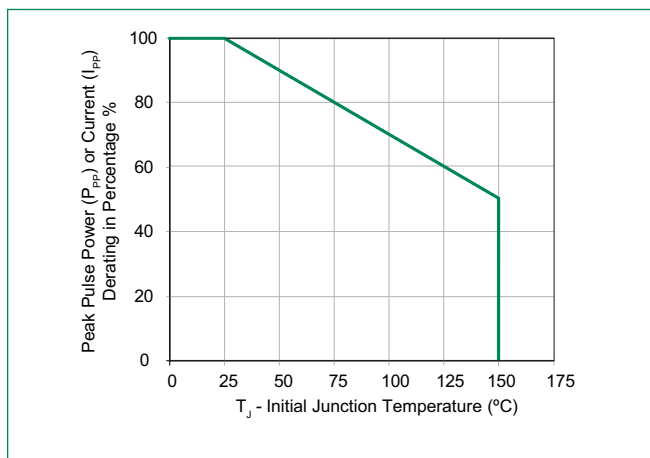


Figure 4 - Pulse Waveform

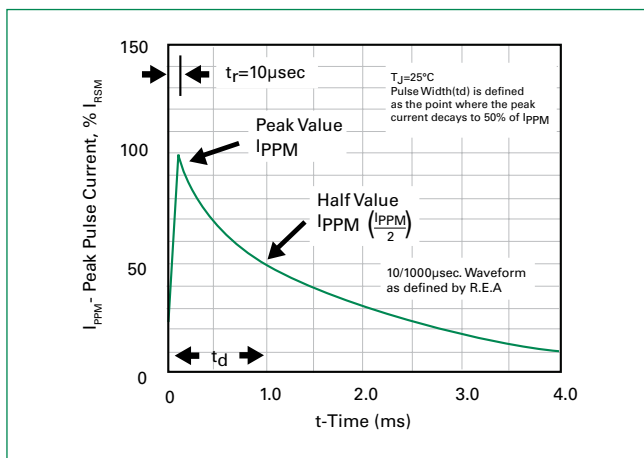


Figure 5 - Typical Junction Capacitance

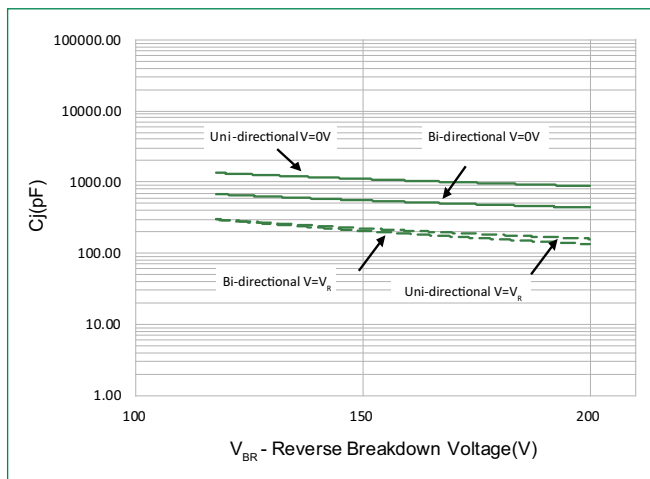
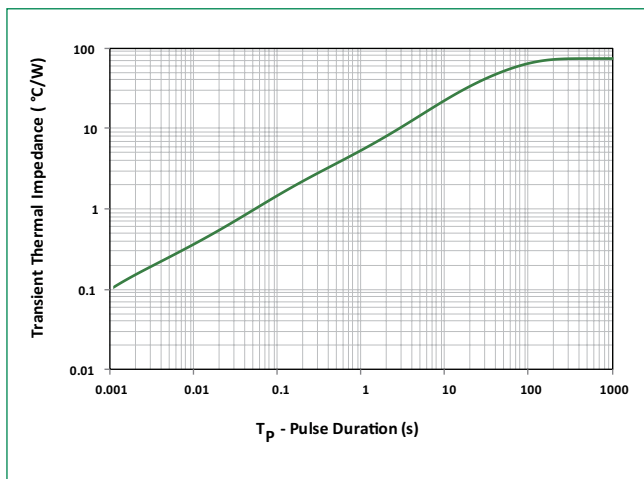


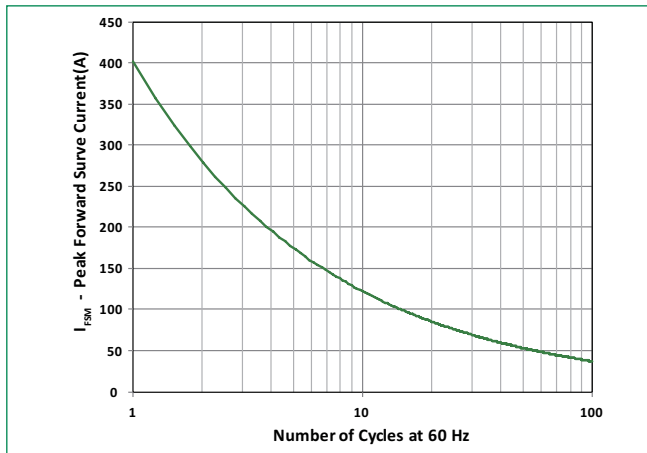
Figure 6 - Typical Transient Thermal Impedance



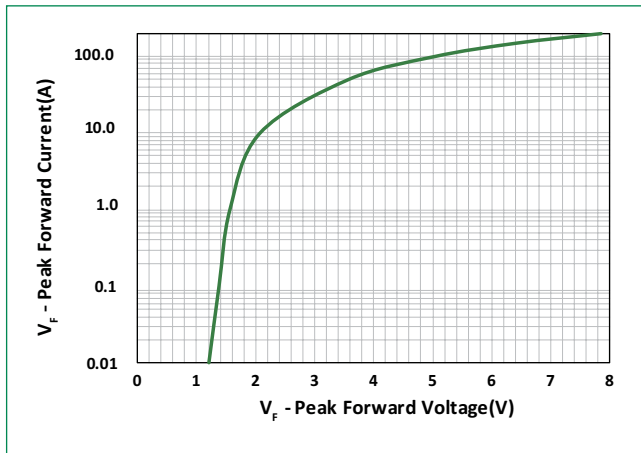
# TP5.0SMDJ Series

## Surface Mount - 5000W

**Figure 7 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional Only**

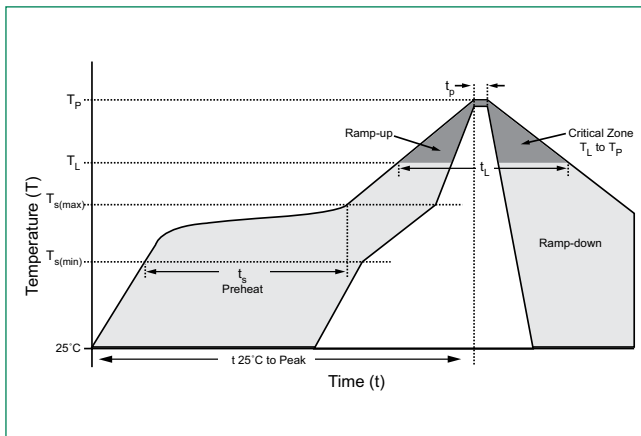


**Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)**



### Soldering Parameters

<b>Reflow Condition</b>		Lead-free assembly
<b>Pre Heat</b>	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 120 secs
<b>Average ramp up rate (Liquidus Temp (<math>T_L</math>) to peak)</b>		3°C/second max
<b><math>T_{s(max)}</math> to <math>T_L</math> - Ramp-up Rate</b>		3°C/second max
<b>Reflow</b>	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_s$ )	60 – 150 seconds
<b>Peak Temperature (<math>T_p</math>)</b>		260 <sup>+0/-5</sup> °C
<b>Time within 5°C of actual peak Temperature (<math>t_p</math>)</b>		30 seconds
<b>Ramp-down Rate</b>		6°C/second max
<b>Time 25°C to peak Temperature (<math>T_p</math>)</b>		8 minutes max.
<b>Do not exceed</b>		260°C



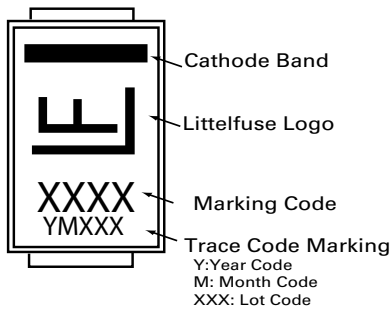
### Physical Specifications

<b>Weight</b>	0.007 ounce, 0.21 grams
<b>Case</b>	JEDEC DO214AB. Molded plastic body over glass passivated junction
<b>Polarity</b>	Color band denotes positive end (cathode) except Bidirectional.
<b>Terminal</b>	Matte Tin-plated leads, Solderable per JESD22-B102

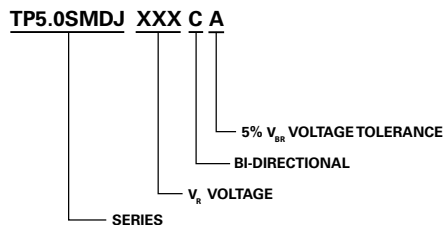
### Environmental Specifications

<b>High Temp. Storage</b>	JESD22-A103
<b>HTRB</b>	JESD22-A108
<b>Temperature Cycling</b>	JESD22-A104
<b>MSL</b>	JEDEC-J-STD-020, Level 1
<b>H3TRB</b>	JESD22-A101
<b>RSH</b>	JESD22-A111

### Part Marking System



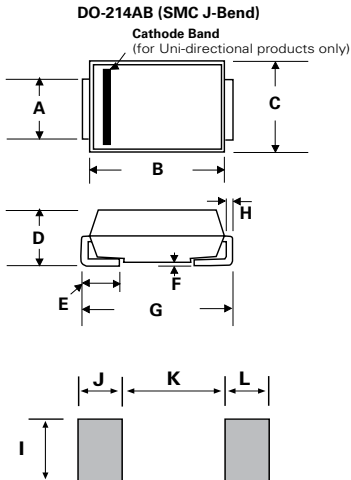
### Part Numbering System



# TP5.0SMDJ Series

Surface Mount - 5000W

### Dimensions

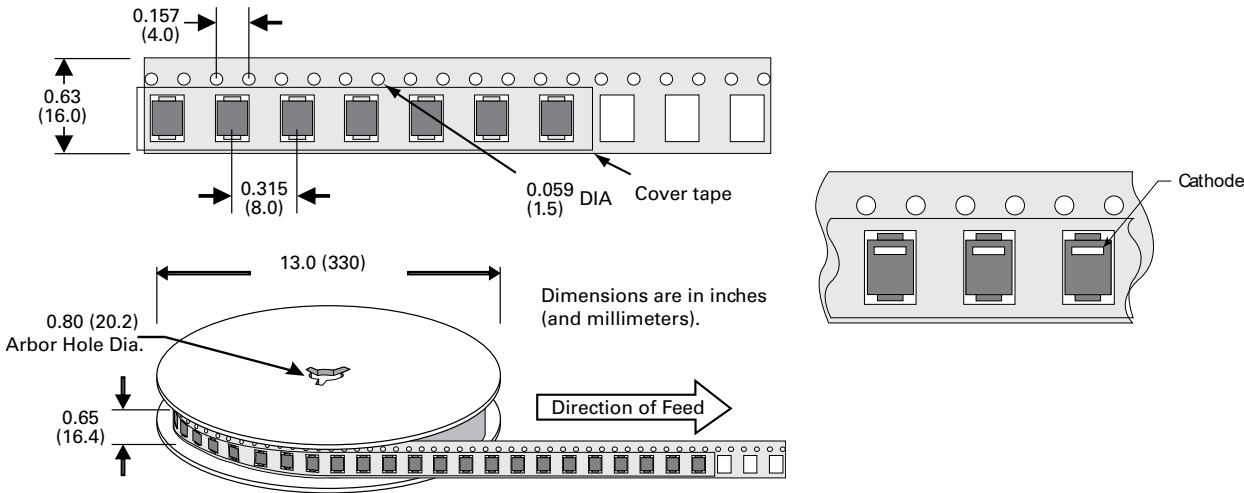


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.114	0.126	2.900	3.200
B	0.260	0.280	6.600	7.110
C	0.220	0.245	5.590	6.220
D	0.079	0.103	2.060	2.620
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.305	0.320	7.750	8.130
H	0.006	0.012	0.152	0.305
I	0.129	-	3.300	-
J	0.094	-	2.400	-
K	-	0.165	-	4.200
L	0.094	-	2.400	-

### Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
TP5.0SMDJxxxXX	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481

### Tape and Reel Specification



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